

X-Class HiPerFET™ **Power MOSFET**

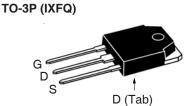
IXFQ60N60X IXFH60N60X

600V 60A $55m\Omega$

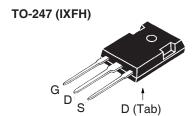
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode







Symbol	Test Conditions	Maximum Ratings		
V _{DSS}	$T_{_{\rm J}} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	600	V	
V _{DGR}	$T_J = 25^{\circ}C$ to 150°C, $R_{GS} = 1M\Omega$	600	V	
V _{GSS}	Continuous	±30	V	
V _{GSM}	Transient	±40	V	
I _{D25}	$T_{c} = 25^{\circ}C$	60	Α	
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	120	Α	
I _A	$T_c = 25^{\circ}C$	30	Α	
E _{as}	$T_{c} = 25^{\circ}C$	2.5	J	
dv/dt	$I_{_{\mathrm{S}}} \le I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \le V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \le 150^{\circ}\mathrm{C}$	50	V/ns	
P _D	T _c = 25°C	890	W	
T _J		-55 +150	°C	
T_{JM}		150	°C	
T _{stg}		-55 +150	°C	
T _L	Maximum Lead Temperature for Soldering	300	°C	
T _{SOLD}	1.6 mm (0.062in.) from Case for 10s	260	°C	
M _d	Mounting Torque	1.13 / 10	Nm/lb.in	
Weight	TO-3P TO-247	5.5 6.0	g g	



G = Gate	D	= Drain
S = Source	Tab	= Drain

Features

- International Standard Packages
- Low R_{DS(ON)} and Q_G
 Avalanche Rated
- Low Package Inductance

Advantages

- High Power Density
- Easy to Mount
- Space Savings

Applications

- Switch-Mode and Resonant-Mode **Power Supplies**
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

Symbol (T = 25°C, l	Test Conditions Unless Otherwise Specified)	Charad Min.	cteristic	Values Max	.
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$	600			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 8mA$	2.5		4.5	V
I _{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			25 1.25	μA mA
R _{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1			55	mΩ



•		acteristic Values		
$(T_{J} = 25^{\circ}C, L)$	Inless Otherwise Specified)	Min.	Тур.	Max
g _{fs}	$V_{DS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$	24	40	S
R _{Gi}	Gate Input Resistance		1.4	Ω
C _{iss}			5800	pF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		4130	pF
C _{rss}			40	pF
	Effective Output Capacitance			
$C_{o(er)}$	Energy related $\int V_{GS} = 0V$		285	pF
C _{o(tr)}	Time related $V_{DS}^{GS} = 0.8 \cdot V_{DSS}$		930	pF
t _{d(on)}	Resistive Switching Times		27	ns
t, (23	ns
t _{d(off)}	$V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$ $R_{G} = 2\Omega$ (External)		90	ns
t,	II _G – 232 (External)		13	ns
$Q_{g(on)}$			143	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		30	nC
Q _{gd}			70	nC
R _{thJC}				0.14 °C/W
R _{thCS}			0.25	°C/W

Source-Drain Diode

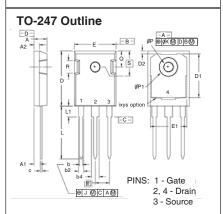
Symbol	ol Test Conditions Characteristic Values				
$(T_{J} = 25^{\circ}C, l)$	Jnless Otherwise Specified)	Min.	Тур.	Max	
I _s	$V_{GS} = 0V$			60	Α
I _{SM}	Repetitive, pulse Width Limited by $T_{_{JM}}$			240	Α
$V_{_{\mathrm{SD}}}$	$I_F = I_S$, $V_{GS} = 0V$, Note 1			1.4	V
$\left\{ egin{array}{c} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} & \\ \mathbf{I}_{RM} & \end{array} ight\}$	$I_F = 30A$, -di/dt = 100A/ μ s $V_R = 100V$		200 1.9 18.5		ns µC A

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-3P Outline ⊕ (+)-Œ PINS: 1 - Gate 2, 4 - Drain 3 - Source MILLIMETERS MIN MAX INCHE SYM .193 .059 .065 Α 4.70 4.90 Α1 Α2 0.90 .087 Ь4 19.80 .665 .610



.134 .280 .201

øP1

13.50 5.45 19.80 3.40 3.20

3.40

SYM	INCH	INCHES		METERS	
SYM	MIN	MAX	MIN	MAX	
Α	.190	.205	4.83	5.21	
A1	.090	.100	2.29	2.54	
A2	.075	.085	1.91	2.16	
Ь	.045	.055	1.14	1.40	
b2	.075	.087	1.91	2.20	
b4	.115	.126	2.92	3.20	
С	.024	.031	0.61	0.80	
D	.819	.840	20.80	21.34	
D1	.650	.690	16.51	17.53	
D2	.035	.050	0.89	1.27	
E	.620	.635	15.75	16.13	
E1	.545	.565	13.84	14.35	
е	.215	BSC	5.45 BSC		
J		.010		0.25	
K		.025		0.64	
L	.780	.810	19.81	20.57	
L1	.150	.170	3.81	4.32	
ØΡ	.140	.144	3.55	3.65	
øP1	.275	.290	6.99	7.37	
Q	.220	.244	5.59	6.20	
R	.170	.190	4.32	4.83	
S	.242	BSC	6.15 BSC		

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Fig. 1. Output Characteristics @ $T_J = 25^{\circ}C$

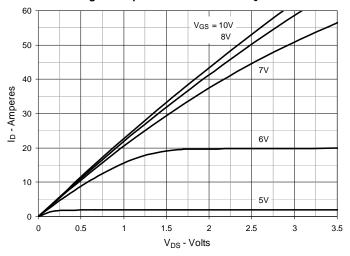


Fig. 2. Extended Output Characteristics @ T_J = 25°C

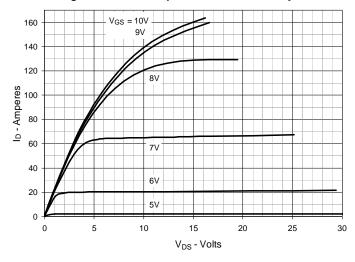


Fig. 3. Output Characteristics @ T_J = 125°C

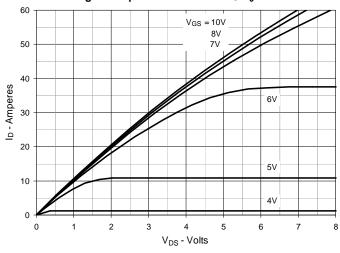


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 30A Value vs. Junction Temperature

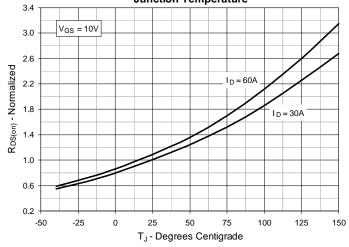


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 30A Value vs.

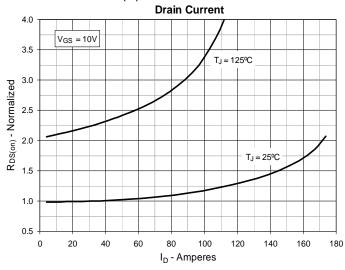
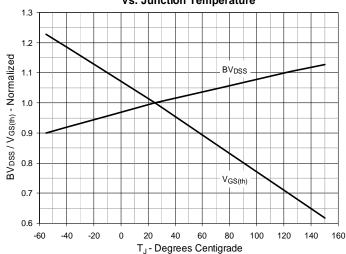
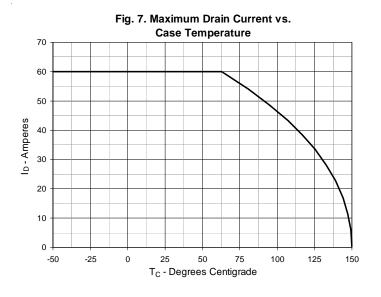
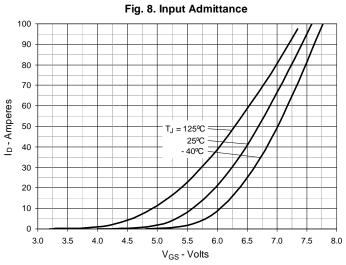


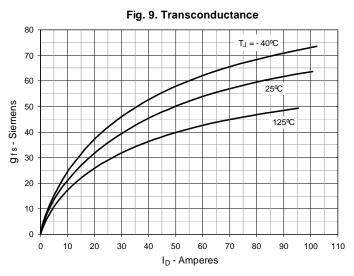
Fig. 6. Normalized Breakdown & Threshold Voltages vs. Junction Temperature

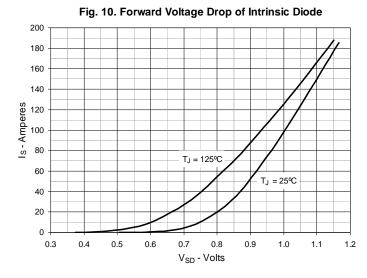


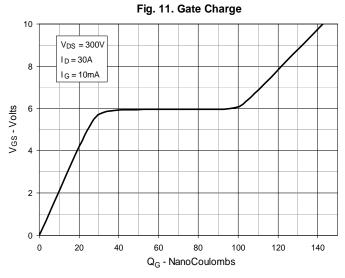


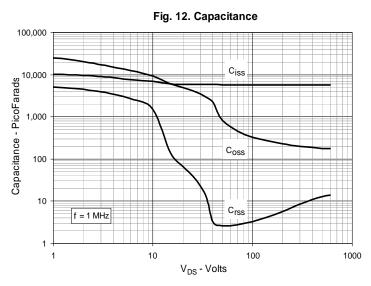






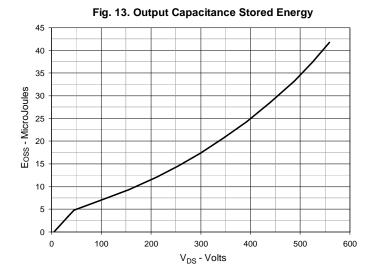






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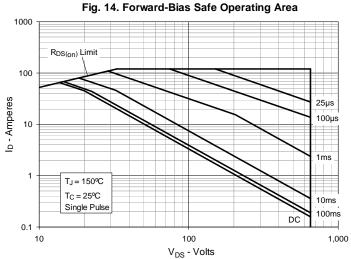


Fig. 15. Maximum Transient Thermal Impedance

